**Product data sheet** 

## 1. General description

WSJM65R360B is a high voltage N-channel MOSFET in TO263 package, which utilizes the advanced super-junction technology to provide superior FOM  $R_{\rm DS(on)}{}^{\star}Q_{\rm g}$  among silicon based MOSFETs. It is particularly suitable for applications require extreme high efficiency and power density.



### 2. Features and benefits

- Superior FOM R<sub>DS(on</sub>)\*Q<sub>g</sub>
- Extremely low switching loss
- 100% avalanche tested

## 3. Applications

- Chargers
- Adapters
- Lighting
- · Flyback topologies for high efficiency power supplies

#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit		
Absolute	Absolute maximum rating								
V <sub>DS</sub>	drain-source voltage				650		V		
$V_{GS}$	gate-source voltage				±30		V		
I <sub>D</sub>	continuous drain current	T <sub>mb</sub> = 25 °C			10		Α		
P <sub>tot</sub>	power dissipation	T <sub>mb</sub> = 25 °C			96		W		
T <sub>j</sub>	junction temperature			-55 to 150			°C		
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit		
Static cha	aracteristics								
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = 10 \text{ V}, I_{D} = 5.5 \text{ A}$		-	335	360	mΩ		
Dynamic characteristics									
Q <sub>G(tot)</sub>	total gate charge	$I_D = 5.5 \text{ A}; V_{DS} = 400 \text{ V}; V_{GS} = 10 \text{ V}$		-	18	-	nC		
E <sub>oss</sub>	coss stored erergy	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$		-	2.6	-	μJ		

# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		D
2	D	drain		
3	S	source	0	$G \longrightarrow \overline{A}$
mb	D	mounting base; connected to drain	1 3	sym300 S

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WSJM65R360B	TO263	WSJM65R360BJ	Reel	800	TO263d	17-Mar-2023

## 7. Marking

#### **Table 4. Marking codes**

Type number	Marking codes
WSJM65R360B	WSJM 65R360B

# 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>DS</sub>	drain-source voltage			650	V
V <sub>GS</sub>	gate-source voltage			±30	V
I <sub>D</sub>	continuous drain current	T <sub>mb</sub> = 25 °C		10	Α
		T <sub>mb</sub> = 100 °C		6.6	Α
I <sub>DM</sub>	pulsed drain current	T <sub>mb</sub> = 25 °C		40	Α
P <sub>tot</sub>	power dissipation	T <sub>mb</sub> = 25 °C		96	W
E <sub>AS</sub>	single pulse drain-to- source avalanche	$I_{AS} = 3.3 \text{ A}; R_{GS} = 25 \Omega; V_{DD} = 50 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		54	mJ
E <sub>AR</sub>	repetitive avalanche energy	$I_{AS} = 3.3 \text{ A}; R_{GS} = 25 \Omega; V_{DD} = 50 \text{ V};$ $T_j = 25 \text{ °C}$		0.6	mJ
I <sub>AS</sub>	avalanche current, single pulse			3.3	А
dv/dt	MOSFET dv/dt ruggedness			50	V/ns
dv/dt	reverse diode dv/dt			15	V/ns
dl <sub>F</sub> /dt	maximum diode commutation speed			500	A/µs
T <sub>stg</sub>	storage temperature			-55 to 150	°C
T <sub>j</sub>	junction temperature			-55 to 150	°C

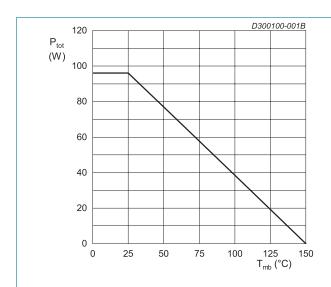


Fig. 1. Total power dissipation as a function of mounting base temperature

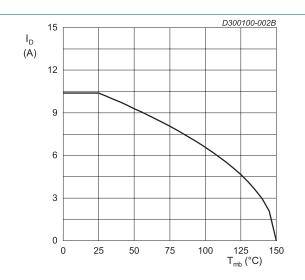


Fig. 2. Continuous Drain Current as a function of mounting base temperature

## 9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base			-	0.97	1.3	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air		-	60	-	K/W

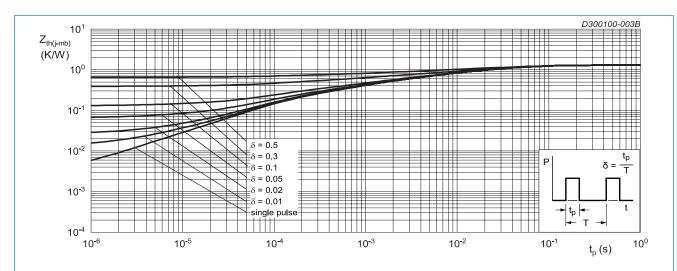


Fig. 3. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum values

## 10. Characteristics

#### **Table 7. Characteristics**

T<sub>i</sub> = 25 °C unless otherwise noted

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V$		650	-	-	V
$V_{\text{GS(th)}}$	gate-source threshold voltage	$I_D = 250 \mu A; V_{DS} = V_{GS}$		2.5	-	4.5	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 650 \text{ V}; V_{GS} = 0 \text{ V}$		-	-	1	μA
		$V_{DS} = 650 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 ^{\circ}\text{C}$		-	-	10	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$		-	-	±100	nA
$R_{\text{DS(on)}}$	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 5.5 \text{ A}$		-	335	360	mΩ
$R_G$	gate resistance	f = 1 MHz		-	18	-	Ω
Dynamic	characteristics					'	
Q <sub>G(tot)</sub>	total gate charge	$I_D = 5.5 \text{ A}; V_{DS} = 400 \text{ V}; V_{GS} = 10 \text{ V}$		-	18	-	nC
Q <sub>GS</sub>	gate-source charge			-	4.1	-	nC
$Q_{GD}$	gate-drain charge			-	7.0	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 400 V; V <sub>GS</sub> = 0 V; f = 1 MHz		-	808	-	pF
C <sub>oss</sub>	output capacitance			-	23	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	1.8	-	pF
$C_{\text{o(er)}}$	effective output capacitance, energy related	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$		-	33	-	pF
$C_{o(tr)}$	effective output capacitance, time related			-	148	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 400 \text{ V}; V_{GS} = 10 \text{ V}; R_G = 2 \Omega;$		-	30	-	ns
t <sub>r</sub>	rise time	$I_{D} = 5.5 A$		-	9.6	-	ns
$t_{\text{d(off)}}$	turn-off delay time			-	52	-	ns
t <sub>f</sub>	fall time			-	14	-	ns
Source-d	rain diode						
V <sub>SD</sub>	source-drain voltage	$V_{GS} = 0 \text{ V; } I_S = 5.5 \text{ A}$		-	8.0	1.1	V
Is	body-diode continuous current	T <sub>mb</sub> = 25 °C		-	-	10	А
t <sub>rr</sub>	reverse recovery time	$V_R = 400 \text{ V}; I_F = 5.5 \text{ A}; dI_F/dt = 100 \text{ A/}\mu\text{s}$		-	229	-	ns
Q <sub>rr</sub>	reverse recovered charge			-	2.3	-	μC
I <sub>rrm</sub>	reverse recovery current			-	20	-	Α

D300100-005

### **Super-Junction Power MOSFET**

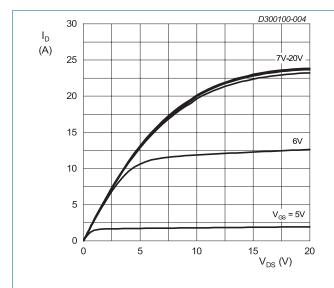


Fig. 4. Drain current as a function of drain-source voltage; typical values

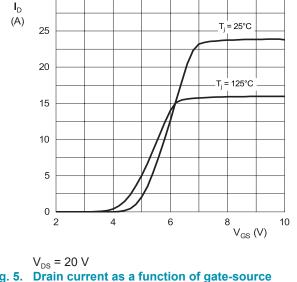
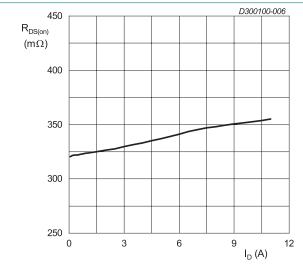
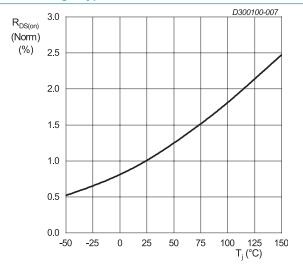


Fig. 5. Drain current as a function of gate-source voltage; typical values



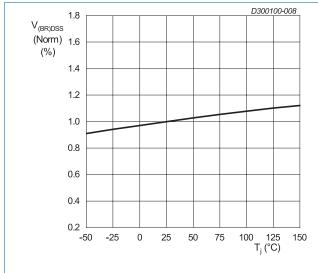
V<sub>GS</sub> = 10 V

Fig. 6. Drain-source on-state resistance as a function of drain current; typical values



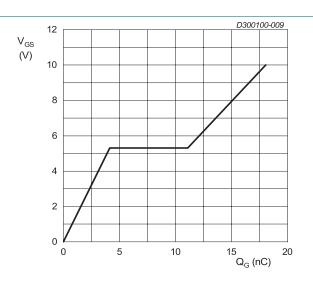
V<sub>GS</sub> = 10 V; I<sub>D</sub> = 5.5 A

Fig. 7. Normalized drain-source on-state resistance as a function of junction temperature



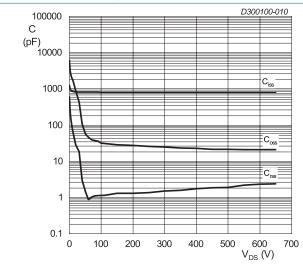
 $I_D = 250 \mu A$ 

Fig. 8. Normalized drain-source breakdown voltage as a function of junction temperature

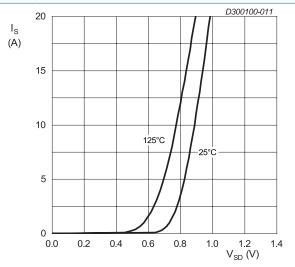


 $I_D$  = 5.5 A;  $V_{DS}$  = 400 V

Fig. 9. Gate-source voltage as a function of gate charge; typical values



V<sub>GS</sub> = 0 V; f = 1 MHz Fig 10. Capacitances as a function of drain-source voltage; typical values



V<sub>GS</sub> = 0 V Fig 11. Source current as a function of source-drain voltage; typical values

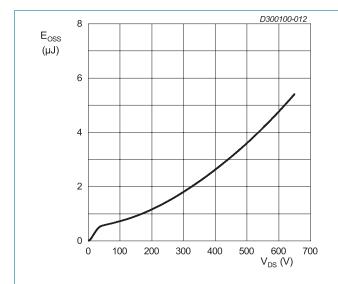
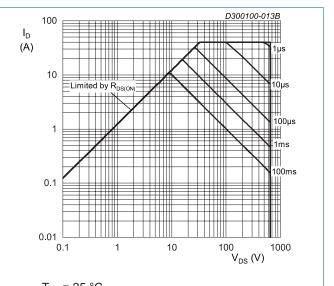
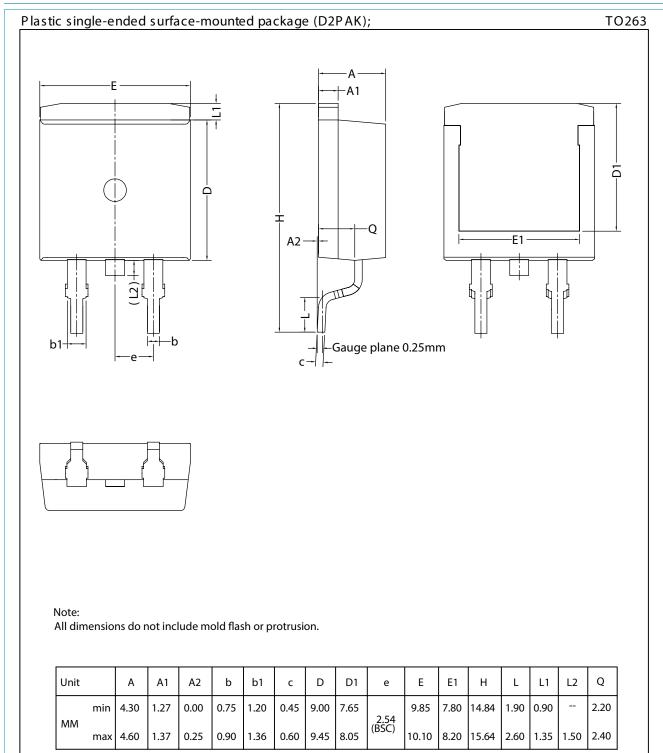


Fig. 12. Output capacitance stored energy as a function of drain-source voltage



 $T_{mb}$  = 25 °C Fig. 13. Safe operating area

## 11. Package outline



## 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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